

# MCR218-2G, MCR218-4G, MCR218-6G





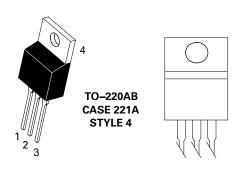
## **Description**

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supplies; or wherever half-wave silicon gate-controlled, solid-state devices are needed.

#### **Features**

- Glass-Passivated Junctions
- Blocking Voltage to 400 Volts
- TO-220 Construction Low Thermal Resistance, High Heat Dissipation and Durability

## **Pin Out**



#### **Functional Diagram**



## **Additional Information**









#### **Maximum Ratings** (T<sub>1</sub> = 25°C unless otherwise noted) Rating Symbol Value Unit $V_{\text{DRM'}}$ Peak Repetitive Off-State Voltage (Note 1) MCR68-2 50 (- 40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open) On-State RMS Current 12 Α I<sub>TM (RMS)</sub> (180° Conduction Angles; T<sub>c</sub> = 85°C) Peak Discharge Current (Note 2) $I_{\overline{\mathsf{TM}}}$ 300 Α Average On-State Current 8.0 Α I<sub>T(AV)</sub> (180° Conduction Angles; T<sub>c</sub> = 85°C) Peak Non-Repetitive Surge Current 100 Α I<sub>TSM</sub> (1/2 Cycle, Sine Wave 60 Hz, T<sub>J</sub> = 125°C) $I^2t$ Circuit Fusing Consideration (t = 8.3 ms) 40 A<sup>2</sup>sec Forward Peak Gate Current (Pulse Width ≤ 1.0 µsec, T<sub>c</sub>= 80°C) $I_{GM}$ 2.0 Α

- Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.
- V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- 2. Ratings apply for tw = 1 ms. See Figure 1 for I<sub>TM</sub> capability for various duration of an exponentially decaying current waveform, tw is defined as 5 time constants of an exponentially decaying current pulse.

#### **Thermal Characteristics**

Forward Peak Gate Current (Pulse Width ≤ 1.0 µsec, T<sub>c</sub>= 85°C)

Forward Average Gate Power (t = 8.3 ms, TC = 85°C)

Operating Junction Temperature Range

Storage Temperature Range

Mounting Torque

Rating		Symbol	Value	Unit	
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient	R <sub>ejc</sub> R <sub>eja</sub>	2.0 60	°C/W	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds		T <sub>L</sub>	260	°C	

#### **Electrical Characteristics** - **OFF** (T<sub>1</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Forward or Reverse Blocking Current	T <sub>1</sub> = 25°C	I <sub>DRM</sub> ,	-	-	10	A
(VD = Rated VDRM and VRRM; Gate Open)	ated VDRM and VRRM; Gate Open) T <sub>J</sub> = 125°C		-	-	2.0	mA

#### **Electrical Characteristics - ON** (T<sub>1</sub> = 25°C unless otherwise noted)

Characteristic		Min	Тур	Max	Unit
Peak Forward On–State Voltage (Note 2) $ (I_{TM} = 32 \text{ A})(I_{TM} = 24 \text{ A}) \text{ (Note 3)} $ $ (I_{TM} = 300 \text{ A}, \text{ tw} = 1 \text{ ms)} \text{ (Note 4)} $	V <sub>TM</sub>	_ _	6.0	2.2	V
Gate Trigger Current (Continuous dc) ( $V_D = 12 \text{ V}; R_L = 100 \Omega$ )	I <sub>GT</sub>	2.0	7.0	30	mA
Gate Trigger Voltage (Continuous dc) ( $V_D = 12 \text{ V}; R_L = 100 \Omega$ )	V <sub>GT</sub>	_	0.65	1.5	V
Gate Trigger Non-Current (Continuous dc) $(V_D = 12 \text{ V}; R_L = 100 \Omega)$		0.2	0.40	_	V
Holding Current (V <sub>D</sub> = 12 V, Initiating Current = 200 mA, Gate Open))		3.0	15	50	mA
Latch Current ( $V_D = 12 \text{ V}, I_G = 30 \text{ mA}$ )		_	35	80	mA
Gate Controlled Turn-On Time (Note 5) $(V_D = Rated V_{DRM'} I_G = 150 \text{ mA}) (I_{TM} = 24 \text{ A Peak})$	V <sub>GT</sub>	_	1.0	_	μs

20

0.5

-40 to +125

-40 to +150

8.0

W

°C

°C

 $I_{\text{GM}}$ 

 $P_{G(AV)}$ 

Τ,

 $\mathsf{T}_{\mathsf{stg}}$ 

## **Thyristors**

#### **Dynamic Characteristics** Characteristic **Symbol** Min Тур Max Unit Critical Rate of Rise of Off-State Voltage dv/dt 10 V/µs $(V_D = Rated V_{DRM}, Exponential Waveform, Gate Open, T_J = 125°C)$ Critical Rate of Rise of On-State Current di/dt 75 A/μs $I_{G} = 150 \text{ A}$ T<sub>1</sub> = 125°C

- 3. Pulse duration  $\leq$  300 µs, duty cycle  $\leq$  2%.
- 4. Ratings apply for tw = 1 ms. See Figure 1 for I<sub>TM</sub> capability for various durations of an exponentially decaying current waveform. tw is defined as 5 time constants of an exponentially decaying current pulse.
- 5. The gate controlled turn-on time in a crowbar circuit will be influenced by the circuit inductance.

## **Voltage Current Characteristic of SCR**

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
I <sub>H</sub>	Holding Current

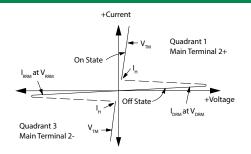
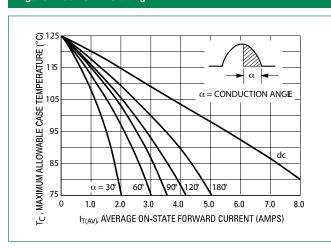




Figure 1. Current Derating



**Thyristors** 

Figure 2. On-State Power Dissipation

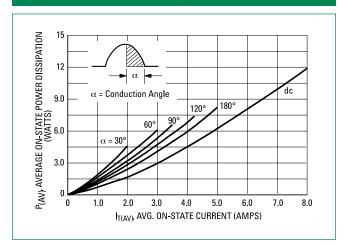


Figure 3. Typical Gate Trigger Current vsTemperature

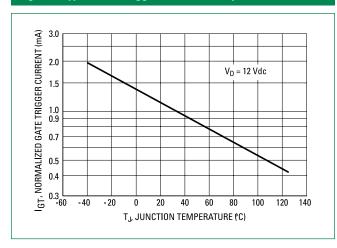


Figure 4. Typical Gate Trigger Voltage vs Temperature

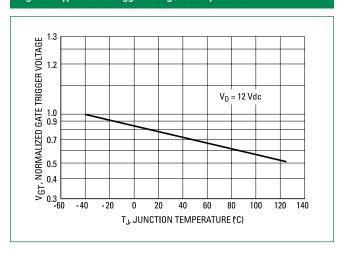


Figure 5. Typical Holding Current vs Temperature

